

**DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **MICROPARTICLE COMPOSITIONS AND METHODS FOR THE MANUFACTURE THEREOF**

the specification of which (check one) \_\_\_ is attached hereto X was filed on Sept. 28, 2001, as Application Serial No. 09/967,462, and was amended on \_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	<u>Yes</u>	<u>No</u>

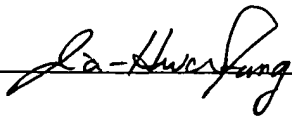
I hereby claim the benefit under Title 35, United States Code, §120 and/or §119(e) of any United States application(s) and/or provisional applications listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application <u>Serial No.</u>	<u>Filing Date</u>	Status <u>Patented, Pending, Abandoned</u>
60/122,172	Sept. 28, 2000	abandoned

I hereby declare that all statements herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements and the like so made are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor Jia-Hwa Fang

Inventor's signature



Date

15 Jan 02

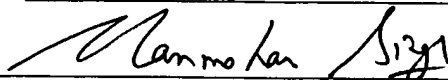
Residence Oakland, California

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Full name of second inventor Manmohan Singh

Inventor's signature



Date

01-15-02

Residence Hercules, California

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Post Office Address 4560 Horton Street, Emeryville, CA 94608

Full name of sole or third inventor Derek O'Hagan

Inventor's signature



Date

1/17/02

Residence Berkeley, California

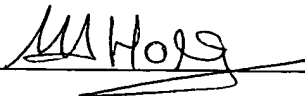
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Full name of sole or fourth inventor Maninder Hora

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Date

01/15/2002

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